

P-Channel Enhancement-Mode Vertical DMOS FET

Features

- ► High input impedance and high gain
- Low power drive requirement
- Ease of paralleling
- Low C_{iss} and fast switching speeds
- Excellent thermal stability
- Integral source-drain diode
- ▶ Free from secondary breakdown

Applications

- Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Analog switches
- Power management
- Telecom switches

Ordering Information

Part Number	Package Option	Packing	
TP2104K1-G	TO-236AB (SOT-23)	3000/Reel	
TP2104N3-G	3-Lead TO-92	1000/Bag	
TP2104N3-G P002			
TP2104N3-G P003			
TP2104N3-G P005	3-Lead TO-92	2000/Reel	
TP2104N3-G P013			
TP2104N3-G P014			

-G denotes a lead (Pb)-free / RoHS compliant package. Contact factory for Wafer / Die availablity. Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	BV _{DSS}
Drain-to-gate voltage	BV_{DGS}
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Typical Thermal Resistance

Package	$oldsymbol{ heta}_{j_{oldsymbol{a}}}$
TO-236AB (SOT-23)	203°C/W
TO-92	132°C/W

General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

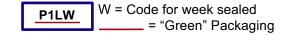
Product Summary

BV_{DSS}/BV_{DGS}	R _{DS(ON)} (max)	V _{GS(th)} (max)
-40V	6.0Ω	-2.0V

Pin Configuration

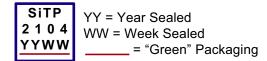


Product Marking



Package may or may not include the following marks: Si or

TO-236AB (SOT-23)



Package may or may not include the following marks: Si or §



TO-92

Thermal Characteristics

Package	Ι _D (continuous) [†]	_D (pulsed)	Power Dissipation @T _A = 25°C	l _{DR} †	I _{DRM}
TO-236AB (SOT-23)	-160mA	-800mA	0.36W	-160mA	-800mA
TO-92	-175mA	-1.0A	0.74W	-175mA	-1.0A

 $[\]dagger$ I_{D} (continuous) is limited by max rated T_{i} .

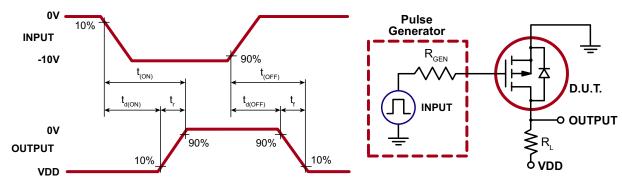
Electrical Characteristics (T_A = 25°C unless otherwise specified)

Sym	Parameter	Min	Тур	Max	Units	Conditions		
BV _{DSS}	Drain-to-source breakdown voltage	-40	-	-	V	$V_{GS} = 0V, I_{D} = -1.0 \text{mA}$		
V _{GS(th)}	Gate threshold voltage	-1.0	-	-2.0	V	$V_{GS} = V_{DS}$, $I_D = -1.0$ mA		
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with temperature	-	5.8	6.5	mV/°C	$V_{GS} = V_{DS}$, $I_D = -1.0$ mA		
I _{GSS}	Gate body leakage	-	-1.0	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
			-	-10	μA	V _{GS} = 0V, V _{DS} = Max Rating		
I _{DSS}	Zero gate voltage drain current	-	-	-1.0	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$, $T_{A} = 125^{\circ}C$		
I _{D(ON)}	On-state drain current	-0.6	-	-	Α	$V_{GS} = -10V, V_{DS} = -25V$		
P	Static drain-to-source on-state	_	_	10	Ω	$V_{GS} = -4.5V, I_{D} = -50mA$		
R _{DS(ON)}	resistance	_	-	6.0	\$2	$V_{GS} = -10V, I_{D} = -500mA$		
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with temperature	-	0.55	1.0	%/°C	$V_{GS} = -10V, I_{D} = -500mA$		
G _{FS}	Forward transconductance	150	200	-	mmho	$V_{DS} = -25V, I_{D} = -500mA$		
C _{ISS}	Input capacitance	-	35	60		V _{GS} = 0V,		
C _{oss}	Common source output capacitance	-	22	30	pF	$V_{DS} = -25V,$		
C _{RSS}	Reverse transfer capacitance	-	8.0	10		f = 1.0 MHz		
t _{d(ON)}	Turn-on delay time	-	4.0	6.0				
t _r	Rise time	-	4.0	8.0	no	$V_{DD} = -25V,$		
t _{d(OFF)}	Turn-off delay time	-	5.0	9.0	ns	$I_D = -500 \text{mA},$ $R_{GEN} = 25\Omega$		
t _f	Fall time	-	5.0	8.0		GEN		
V _{SD}	Diode forward voltage drop	-	-1.2	-2.0	V	$V_{GS} = 0V, I_{SD} = -500 \text{mA}$		
t _{rr}	Reverse recovery time	-	400	-	ns	$V_{GS} = 0V, I_{SD} = -500 \text{mA}$		

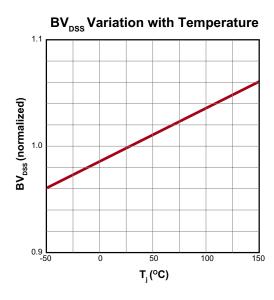
Notes:

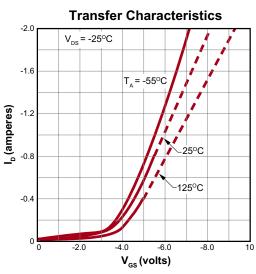
- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

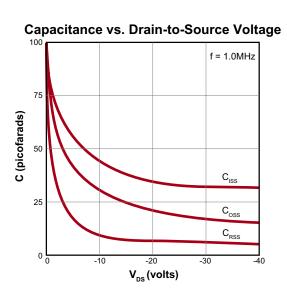
Switching Waveforms and Test Circuit

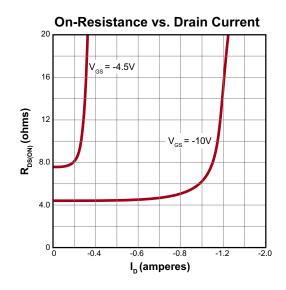


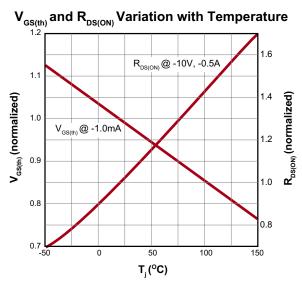
Typical Performance Curves

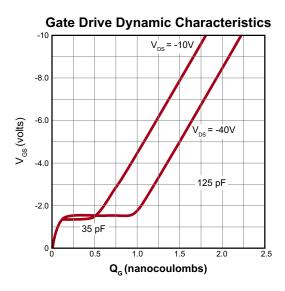




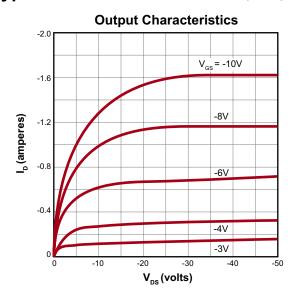


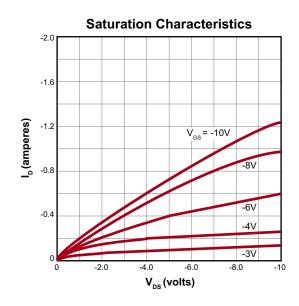


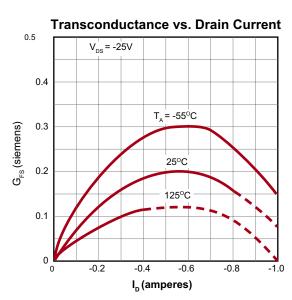


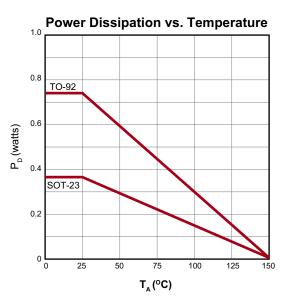


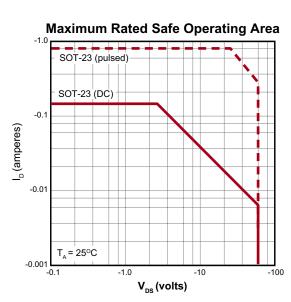
Typical Performance Curves (cont.)

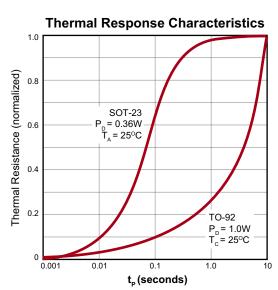






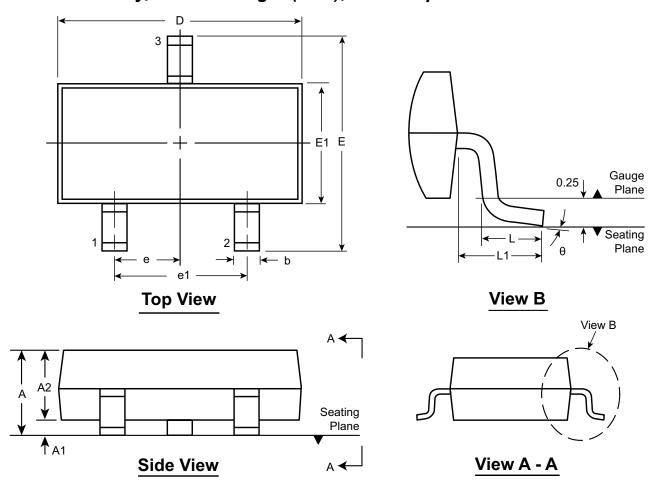






3-Lead TO-236AB (SOT-23) Package Outline (K1)

2.90x1.30mm body, 1.12mm height (max), 1.90mm pitch



Symb	ol	Α	A1	A2	b	D	E	E1	е	e1	L	L1	θ
Discounting	MIN	0.89	0.01	0.88	0.30	2.80	2.10	1.20	0.05	4.00	0.20 [†]	0.54	0 °
Dimension (mm)	NOM	-	-	0.95	-	2.90	-	1.30	0.95 1.90 BSC BSC	0.50	0.54 REF	-	
(11111)	MAX	1.12	0.10	1.02	0.50	3.04	2.64	1.40	500	500	0.60	11	8 º

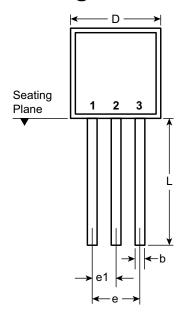
JEDEC Registration TO-236, Variation AB, Issue H, Jan. 1999.

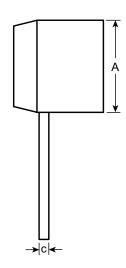
† This dimension differs from the JEDEC drawing.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO236ABK1, Version C041309.

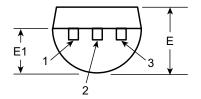
3-Lead TO-92 Package Outline (N3)





Front View

Side View



Bottom View

Symbol		Α	b	С	D	E	E1	е	e1	L
	MIN	.170	.014 [†]	.014 [†]	.175	.125	.080	.095	.045	.500
Dimensions (inches)	NOM	-	-	-	-	-	-	-	-	-
(inches)	MAX	.210	.022 [†]	.022 [†]	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version E041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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^{*} This dimension is not specified in the JEDEC drawing.

[†] This dimension differs from the JEDEC drawing.